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# Dual D-type Flip Flops with Preset and Clear



ADE-205-244A (Z)

2nd. Edition Jul. 2001

### **Description**

The HD74LV74A has independent data, preset, clear, and clock inputs Q and  $\overline{Q}$  outputs in a 14 pin package. The input data is transferred to the output at the rising edge of clock pulse CLK. Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

#### **Features**

- $V_{CC} = 2.0 \text{ V}$  to 5.5 V operation
- All inputs  $V_{IH}$  (Max.) = 5.5 V (@ $V_{CC}$  = 0 V to 5.5 V)
- All outputs  $V_0$  (Max.) = 5.5 V (@ $V_{cc}$  = 0 V)
- Typical  $V_{OL}$  ground bounce < 0.8 V (@ $V_{CC}$  = 3.3 V, Ta = 25°C)
- Typical  $V_{OH}$  undershoot > 2.3 V (@ $V_{CC}$  = 3.3 V, Ta = 25°C)
- Output current  $\pm 6 \text{ mA}$  (@V<sub>CC</sub> = 3.0 V to 3.6 V),  $\pm 12 \text{ mA}$  (@V<sub>CC</sub> = 4.5 V to 5.5 V)

#### **Function Table**

Inputs				Outputs	
PRE	CLR	CLK	D	Q	Q
L	Н	X	Х	Н	L
Н	L	X	Х	L	Н
L	L	X	Х	H* <sup>1</sup>	H* <sup>1</sup>
Н	Н	$\uparrow$	Н	Н	L
Н	Н	<b>↑</b>	L	L	Н
Н	Н	$\downarrow$	Х	$Q_{_{0}}$	$\overline{Q}_{\scriptscriptstyle{0}}$

Note: H: High level

L: Low level

X: Immaterial

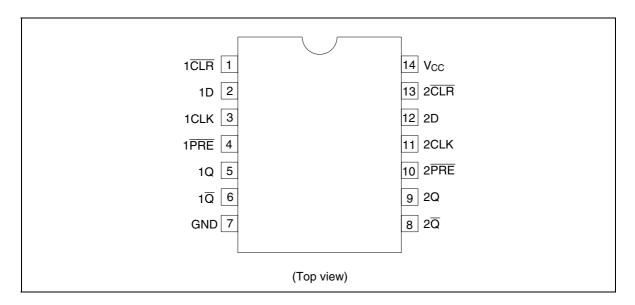
1: Low to high transition

↓: High to low transition

 $Q_0$ : The level of Q immediately before the input conditions shown in the above table are determined.

1.: Q and  $\overline{Q}$  will remain HIGH as long as Preset and Clear are Low, but Q and  $\overline{Q}$  are unpredictable, if Preset and Clear go HIGH simultaneously.

### **Pin Arrangement**



# **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	-0.5 to 7.0	V	
Input voltage range*1	V,	-0.5 to 7.0	V	
Output voltage range*1,2	V <sub>o</sub>	$-0.5 \text{ to V}_{cc} + 0.5$	V	Output: H or L
		-0.5 to 7.0	_	V <sub>cc</sub> : OFF
Input clamp current	I <sub>IK</sub>	-20	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>ok</sub>	±50	mA	$V_{o} < 0 \text{ or } V_{o} > V_{cc}$
Continuous output current	I <sub>o</sub>	±25	mA	$V_o = 0$ to $V_{cc}$
Continuous current through $V_{cc}$ or GND	$I_{\rm cc}$ or $I_{\rm GND}$	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air)* <sup>3</sup>	P <sub>T</sub>	785	mW	SOP
		500	=	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

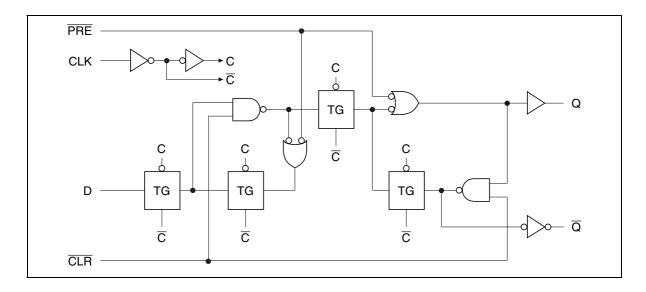
- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

# **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	2.0	5.5	V	
Input voltage range	V <sub>i</sub>	0	5.5	V	
Output voltage range	V <sub>o</sub>	0	V <sub>cc</sub>	V	
Output current	I <sub>OH</sub>	_	-50	μΑ	$V_{cc} = 2.0 \text{ V}$
		_	-2	mA	$V_{cc} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-6		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
	I <sub>OL</sub>	_	50	μΑ	V <sub>cc</sub> = 2.0 V
		_	2	mA	$V_{cc} = 2.3 \text{ to } 2.7 \text{ V}$
		_	6		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt /Δν	0	200	ns/V	$V_{cc} = 2.3 \text{ to } 2.7 \text{ V}$
		0	100		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

# Logic Diagram



### **DC Electrical Characteristics**

 $Ta = -40 \text{ to } 85^{\circ}\text{C}$ 

Item	Symbol	V <sub>cc</sub> (V)*	Min	Тур	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>	2.0	1.5	_	_	٧	
		2.3 to 2.7	$V_{cc} \times 0.8$	_	_	_	
		3.0 to 3.6	$V_{cc} \times 0.8$	_	_	_	
		4.5 to 5.5	$V_{cc} \times 0.8$	_	_	_	
	V <sub>IL</sub>	2.0	_	_	0.3	_	
		2.3 to 2.7	_	_	$V_{cc} \times 0.2$	_	
		3.0 to 3.6	_	_	$V_{cc} \times 0.2$		
		4.5 to 5.5	_	_	$V_{cc} \times 0.2$	_	
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>cc</sub> - 0.1	_	_	V	$I_{oL} = -50 \mu A$
		2.3	2.0	_	_	_	I <sub>OL</sub> = -2 mA
		3.0	2.48	_	_		I <sub>OL</sub> = -6 mA
		4.5	3.8	_	_	_	I <sub>oL</sub> = -12 mA
	V <sub>OL</sub>	Min to Max	_	_	0.1	V	Ι <sub>οι</sub> = 50 μΑ
		2.3	_	_	0.4	_	I <sub>OL</sub> = 2 mA
		3.0	_	_	0.44	_	I <sub>OL</sub> = 6 mA
		4.5	_	_	0.55	_	I <sub>OL</sub> = 12 mA
Input current	I <sub>IN</sub>	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	I <sub>cc</sub>	5.5	_	_	20	μА	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$
Output leakage current	OFF	0	_	_	5	μΑ	$V_{_{\rm I}}$ or $V_{_{\rm O}}$ = 0 V to 5.5 V
Input capacitance	C <sub>IN</sub>	3.3	_	2.0	_	pF	$V_{I} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

# **Switching Characteristics**

 $V_{cc} = 2.5 \pm 0.2 \text{ V}$ 

		Ta =	25°C		Ta = - 85°C	-40 to				
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Maximum clock frequency	t <sub>max</sub>	50	100	_	40	_	MHz	C <sub>L</sub> = 15 pF		
		30	70	_	25	_		C <sub>L</sub> = 50 pF	-	
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	_	9.8	14.8	1.0	17.0	ns	C <sub>L</sub> = 15 pF	PRE/CLR	Q or Q
		_	11.1	16.4	1.0	19.0			CLK	-
		_	13.0	17.4	1.0	20.0		C <sub>L</sub> = 50 pF	PRE/CLR	Q or $\overline{Q}$
		_	14.2	20.0	1.0	23.0			CLK	-
Setup time	t <sub>su</sub>	8.0	_	_	9.0	_	ns		Data	
		7.0	_	_	7.0	_			PRE or CLF	R inactive
Hold time	t <sub>h</sub>	0.5	_	_	0.5	_	ns			
Pulse width	t <sub>w</sub>	8.0	_	_	9.0	_	ns		PRE or CLF	₹ "L"
		8.0	_	_	9.0	_			CLK "H" or	"L"

# **Switching Characteristics (cont)**

 $V_{cc} = 3.3 \pm 0.3 \text{ V}$ 

		Ta =	25°C		Ta = - 85°C	-40 to				
Item	Symbol	Min	Тур	Max	Min	Max	_ Unit	Test Conditions	FROM (Input)	TO (Output)
Maximum clock frequency	t <sub>max</sub>	80	140	_	70	_	MHz	C <sub>L</sub> = 15 pF		
		50	90	_	45	_	_	C <sub>L</sub> = 50 pF	-	
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	_	6.9	12.3	1.0	14.5	ns	C <sub>L</sub> = 15 pF	PRE/CLR	Q or Q
			7.9	11.9	1.0	14.0	_		CLK	_
			9.2	15.8	1.0	18.0	_	C <sub>L</sub> = 50 pF	PRE/CLR	Q or $\overline{Q}$
		_	10.2	15.4	1.0	17.5	_		CLK	=
Setup time	t <sub>su</sub>	6.0	_	_	7.0	_	ns		Data	
		5.0	_	_	5.0	_	_		PRE or CLF	R inactive
Hold time	t <sub>h</sub>	0.5	_	_	0.5	_	ns			
Pulse width	t <sub>w</sub>	6.0	_	_	7.0	_	ns		PRE or CLF	₹ "L"
		6.0	_	_	7.0	_	_		CLK "H" or	"L"

# **Switching Characteristics (cont)**

 $V_{cc} = 5.0 \pm 0.5 \text{ V}$ 

		Ta =	25°C		Ta = - 85°C	40 to				
Item	Symbol	Min	Тур	Max	Min	Max	 Unit	Test Conditions	FROM (Input)	TO (Output)
Maximum clock frequency	t <sub>max</sub>	130	180	_	110	_	MHz	C <sub>L</sub> = 15 pF		
		90	140	_	75	_	<u> </u>	C <sub>L</sub> = 50 pF	-	
Propagation delay time	t <sub>plH</sub> t <sub>pHL</sub>	_	5.0	7.7	1.0	9.0	ns	C <sub>L</sub> = 15 pF	PRE/CLR	Q or Q
		_	5.6	7.3	1.0	8.5	<del></del>		CLK	_
		_	6.6	9.7	1.0	11.0		C <sub>L</sub> = 50 pF	PRE/CLR	Q or $\overline{Q}$
		_	7.2	9.3	1.0	10.5	<u> </u>		CLK	-
Setup time	t <sub>su</sub>	5.0	_	_	5.0	_	ns		Data	
		3.0	_	_	3.0	_			PRE or CLF	R inactive
Hold time	t <sub>h</sub>	0.5	_	_	0.5	_	ns			
Pulse width	t <sub>w</sub>	5.0	_	_	5.0	_	ns		PRE or CLF	₹ "L"
		5.0	_	_	5.0	_	<del></del>		CLK "H" or	"L"

# **Operating Characteristics**

 $C_L = 50 \text{ pF}$ 

Ta =	: 25°C
------	--------

Item	Symbol	$V_{cc}(V)$	Min	Тур	Max	Unit	<b>Test Conditions</b>
Power dissipation capacitance	$C_{\scriptscriptstylePD}$	3.3	_	21.0	_	pF	f = 10 MHz
		5.0	_	23.0	_		

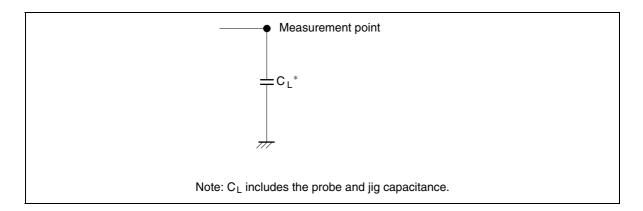
### **Noise Characteristics**

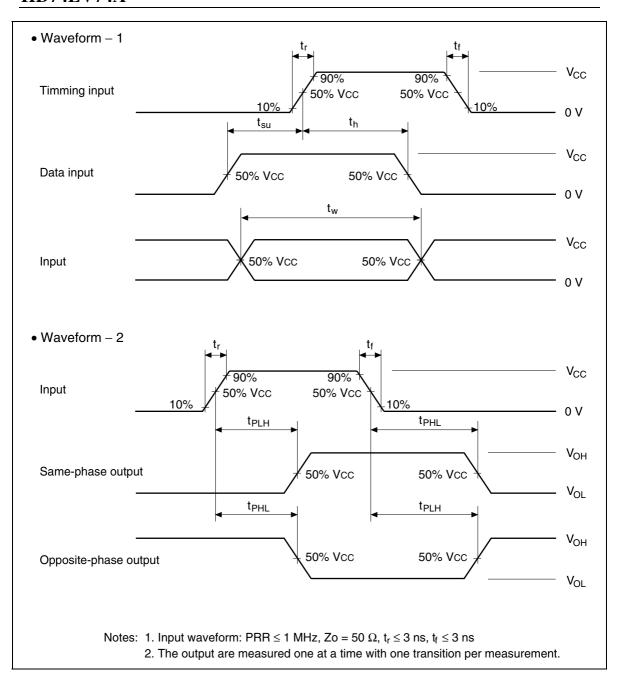
 $C_L = 50 \text{ pF}$ 

Ta = 25°
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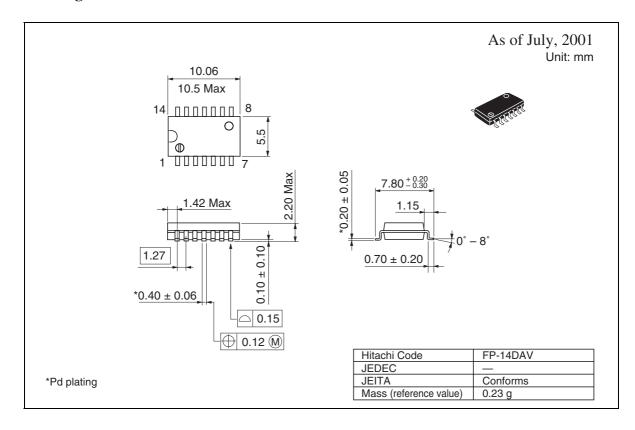
Item	Symbol	$V_{cc}$ (V)	Min	Тур	Max	Unit	<b>Test Conditions</b>
Quiet output, maximum dynamic V <sub>oL</sub>	$V_{_{OL(P)}}$	3.3	_	0.1	0.8	V	
Quiet output, minimum dynamic V <sub>oL</sub>	V <sub>OL (V)</sub>	3.3	_	0	-0.8		
Quiet output, minimum dynamic V <sub>OH</sub>	V <sub>OH (V)</sub>	3.3	_	3.2	_		
High-level dynamic input voltage	V <sub>IH (D)</sub>	3.3	2.31	_	_	V	_
Low-level dynamic inout voltage	V <sub>IL (D)</sub>	3.3	_	_	0.99		

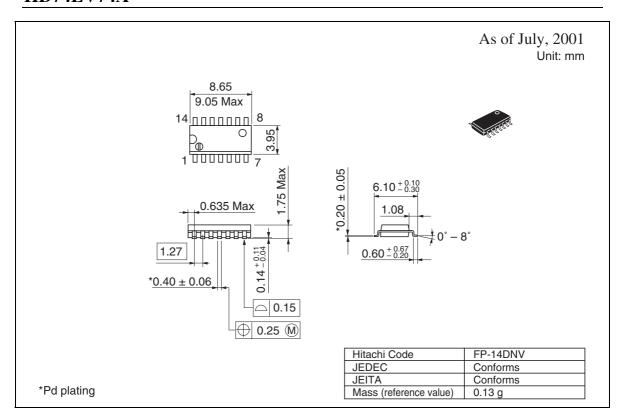
### **Test Circuit**

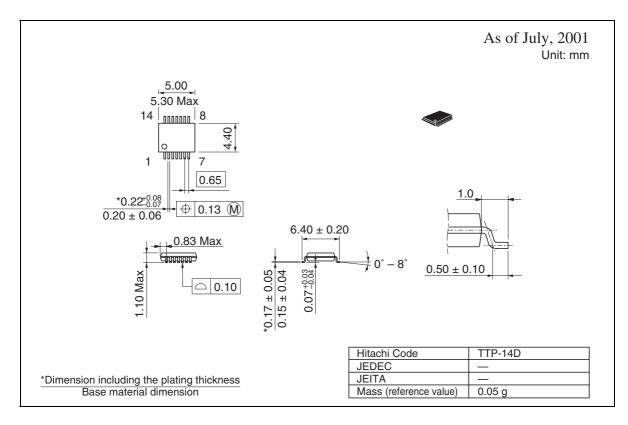




### **Package Dimensions**







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